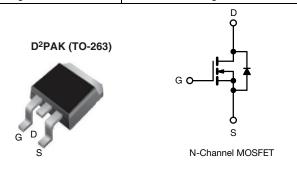
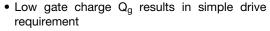
Vishay Siliconix

# **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	600			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 1.2			
Q <sub>g</sub> max. (nC)	42			
Q <sub>gs</sub> (nC)	10			
Q <sub>gd</sub> (nC)	20			
Configuration	Single			



#### **FEATURES**





- Improved gate, avalanche and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Effective Coss specified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

## **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- · High speed power switching

## **TYPICAL SMPS TOPOLOGIES**

Single transistor forward

ORDERING INFORMATION					
Package	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)		
Lead (Pb)-free and Halogen-free	SiHFBC40AS-GE3	SiHFBC40ASTRL-GE3 <sup>a</sup>	SiHFBC40ASTRR-GE3 <sup>a</sup>		
Lood (Dh.) from	IRFBC40ASPbF	IRFBC40ASTRLPbF <sup>a</sup>	IRFBC40ASTRRPbF <sup>a</sup>		
Lead (Pb)-free	SiHFBC40AS-E3	SiHFBC40ASTL-E3 a	SiHFBC40ASTR-E3 a		

### Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (TC	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	600		
Gate-Source Voltage			$V_{GS}$	± 30	V	
Continuous Drain Current <sup>e</sup> V <sub>GS</sub> at 10 V T <sub>C</sub> = 25 °C			I-	6.2		
Continuous Drain Current <sup>e</sup> V <sub>GS</sub> at 10		$T_C = 25 \degree C$ $T_C = 100 \degree C$	I <sub>D</sub>	3.9	Α	
Pulsed Drain Current a, e			I <sub>DM</sub>	25		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	570	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	6.2	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	125	W	
Peak Diode Recovery dV/dt c, e			dV/dt	6.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	- °C	
Soldering Recommendations (Peak temperature) d for 10 s			_	300	7	

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting T<sub>J</sub> = 25 °C, L = 29.6 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 6.2 A (see fig. 12). c. I<sub>SD</sub>  $\leq$  6.2 A, dl/dt  $\leq$  88 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C.

- 1.6 mm from case
- Uses IRFBC40A, SiHFBC40A data and test conditions.



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THERMAL RESISTANCE RATINGS					
PARAMETER SYMBOL TYP. MAX. UNIT					
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0	G/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA <sup>d</sup>	-	0.66	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zoro Coto Voltago Drain Current		V <sub>DS</sub> =	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	ı	-	250	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 3.7 \text{ A}^{\text{ b}}$	1	-	1.2	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS}$	$= 50 \text{ V}, I_D = 3.7 \text{ A}$	3.4	-	-	S
Dynamic							
Input Capacitance	$C_{iss}$		$V_{GS} = 0 V$ ,	-	1036	-	
Output Capacitance	C <sub>oss</sub>	] , ,	$V_{DS} = 25 \text{ V},$	-	136	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	t = 1	f = 1.0 MHz, see fig. 5		7.0	-	pF
Output Capacitance	C <sub>oss</sub>		V <sub>DS</sub> = 1.0 V, f = 1.0 MHz	-	1487	-	- pr
Output Oupuonanoo		$V_{GS} = 0 V$	$V_{DS} = 480 \text{ V}, f = 1.0 \text{ MHz}$	-	36	-	
Output Capacitance Effective	C <sub>oss</sub> eff.		$V_{DS} = 0 \text{ V to } 480 \text{ V}^{\text{ c}}$	-	48	-	
Total Gate Charge	$Q_g$			ı	-	42	
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 \text{ V}$ $I_D = 6.2 \text{ A}, V_{DS} = 480 \text{ V},$ see fig. 6 and 13 b		-	-	10	nC
Gate-Drain Charge	Q <sub>gd</sub>	1	3	-	-	20	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 300 \text{ V}, I_D = 6.2 \text{ A}, \\ R_g = 9.1 \ \Omega, R_D = 47 \ \Omega, \\ \text{see fig. } 10^{\text{ b}}$		-	13	-	ns
Rise Time	t <sub>r</sub>			-	23	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			1	31	-	
Fall Time	t <sub>f</sub>			-	18	-	
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		0.6	-	3.9	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	6.2	^
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	25	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 6.2 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05 °C '	0 0 4 -11/4+ - 400 6 / - h	-	431	647	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 6.2  \text{A}, dI/dt = 100  \text{A/} \mu \text{s}^{ \text{b}}$		-	1.8	2.8	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$
- c.  $C_{OSS}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .
- d. Uses IRHFBC40A, SiHFBC40A data and test conditions.



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

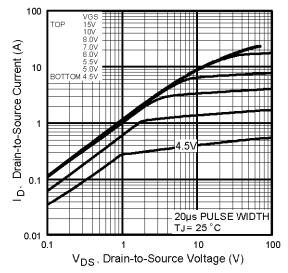


Fig. 1 - Typical Output Characteristics

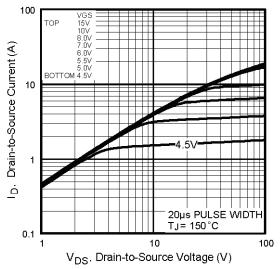


Fig. 2 - Typical Output Characteristics

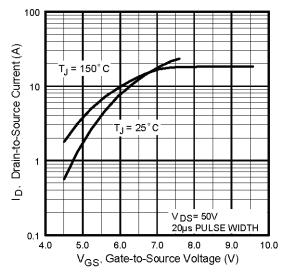


Fig. 3 - Typical Transfer Characteristics

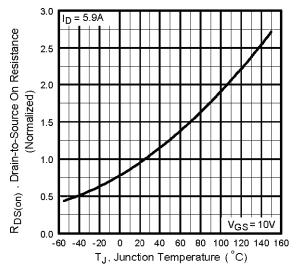


Fig. 4 - Normalized On-Resistance vs. Temperature



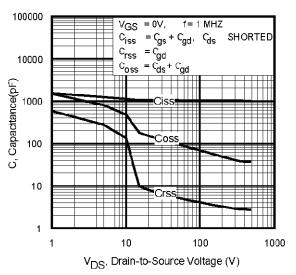


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

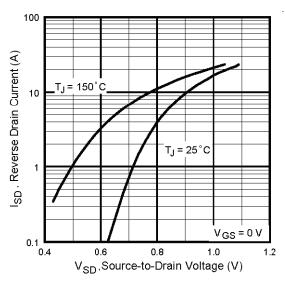


Fig. 7 - Typical Source-Drain Diode Forward Voltage

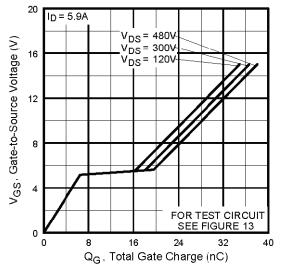


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

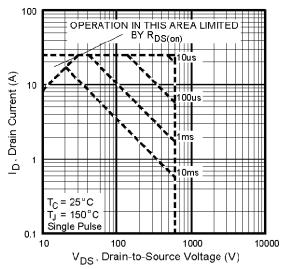


Fig. 8 - Maximum Safe Operating Area



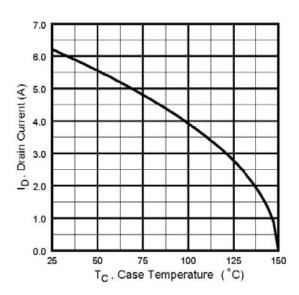


Fig. 9 - Maximum Drain Current vs. Case Temperature

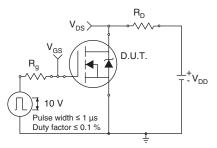


Fig. 10a - Switching Time Test Circuit

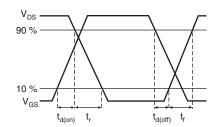


Fig. 10b - Switching Time Waveforms

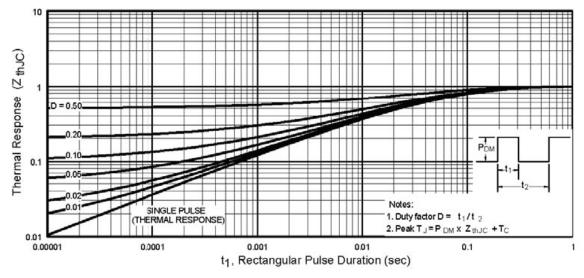


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

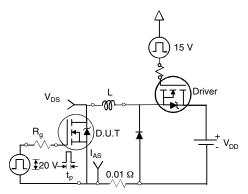


Fig. 12a - Unclamped Inductive Test Circuit

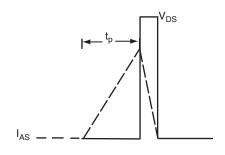


Fig. 12b - Unclamped Inductive Waveforms



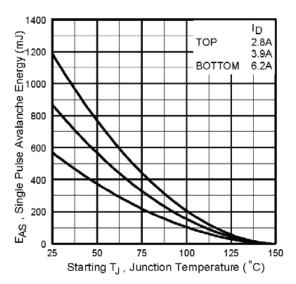


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

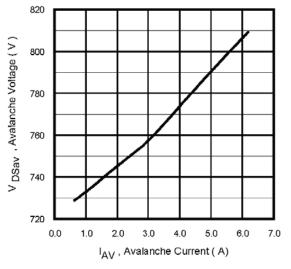


Fig. 12d - Maximum Avalanche Energy vs. Drain Current

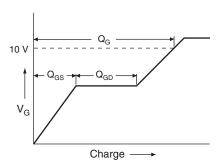


Fig. 13a - Basic Gate Charge Waveform

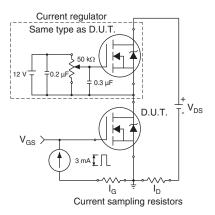
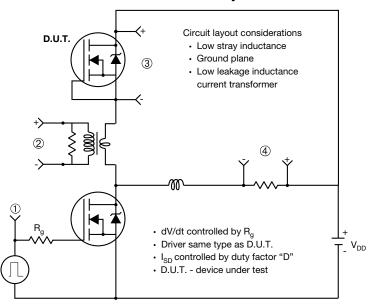


Fig. 13b - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



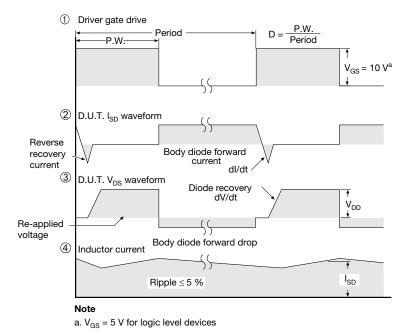


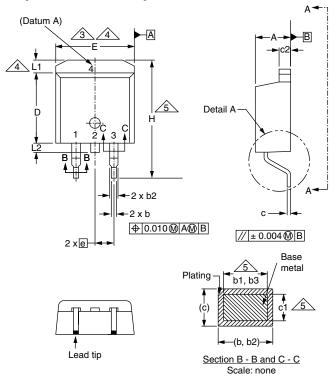
Fig. 14 - For N-Channel

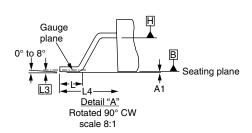
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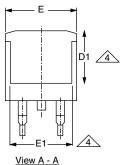




# **TO-263AB (HIGH VOLTAGE)**







	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	ı
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

## Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





# RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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